102692-1 ✔ ACTIVE

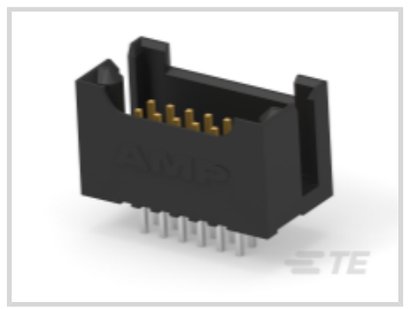
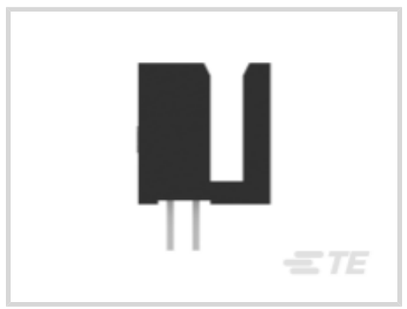
AMPMODU | AMPMODU Headers

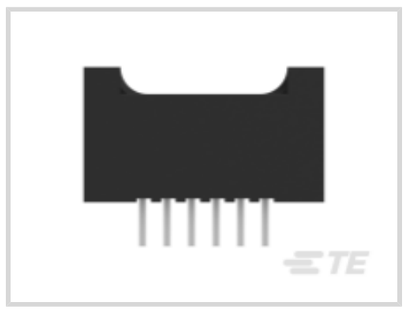
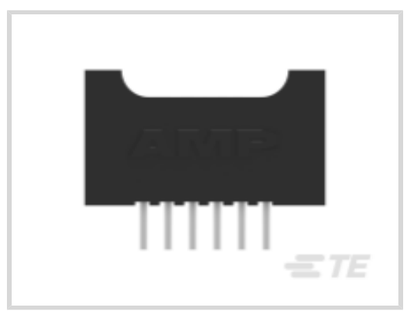
TE Internal #: 102692-1

PCB Mount Header, Vertical, Board-to-Board, 12 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles

PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **12**

Number of Rows: **2**

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	12
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Termination Resistance	12 mΩ
Dielectric Withstanding Voltage (Max)	750 VACrms
Operating Voltage	250 VAC

Body Features

Primary Product Color	Black

Contact Features

Contact Mating Area Length	5.08 mm[.2 in]
Mating Square Post Dimension	.64 mm[.025 in]
	100 – 200 µin
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 µm[30 µin]
Contact Type	Pin
Contact Current Rating (Max)	2 A

Termination Features

Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.57 mm[.18 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Retention	Without
PCB Mount Retention Type	Board Retention Tail
Mating Alignment	With
Mating Alignment Type	Guide Pins
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic

Dimensions

Connector Height	13.97 mm[.55 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	11.43 mm[.45 in]

PCB Thickness (Recommended)	1.4 mm[.055 in]

Usage Conditions

Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

Industry Standards

Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0

Packaging Features

Packaging Quantity	80
Packaging Type	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) SVHC > Threshold: Pb (13% in Component Part) **Article Safe Usage Statements:** Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

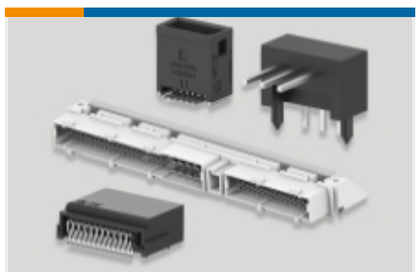
TE Part # 532956-1
12 MODII 2PC CE RCPT ASSY

TE Part # 534204-2
12 MODU 2-PC CE RECP ASSY

Also in the Series | AMPMODU Headers

PCB Connector Mounting(1)

PCB Connector Shrouds(1)



PCB Headers & Receptacles(4875)

PCB Latches, Locks & Retainers(1)

Wire-to-Board Connector Assemblies & Housings(5)

Wire-to-Board Connector Contacts(65)

Customers Also Bought

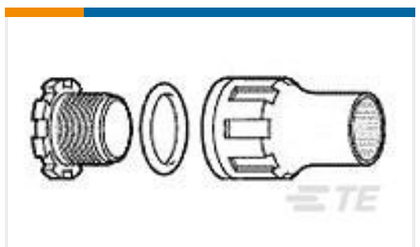
TE Part #5-6609107-4
PS0SXDS3A=C1111

TE Part #1-6609037-2
6EMC1=F8127

TE Part #1658612-3
15 POS HDF RCPT, MS, LEAD FREE

TE Part #1-6609032-3
10VR1=F7206 S0

TE Part #8-31886-1
PIDG R 22-16 COMM 22-18 MIL 8



TE Part #848633-001
CES-4

TE Part #1-1658622-0
50 NOVO MIL/CTR 30DP,LEAD FREE

TE Part #1-794612-2
PIN CONT 20-24 30 GOLD L/P

TE Part #1-794613-2
PIN CONT 26-30 30 GOLD L/P

TE Part #NB13942001
TAT-125-1/4-0-STK

Documents

Product Drawings

12 MODII 2PC HDR DR SHRD

English

CAD Files

Customer View Model

ENG_CVM_102692-1_L2.3d_igs.zip

English

Customer View Model

ENG_CVM_102692-1_L2.2d_dxf.zip

English

Customer View Model

ENG_CVM_102692-1_L2.3d_stp.zip

English

3D PDF

English

Datasheets & Catalog Pages

AMPMODU Interconnetion System

AMPMODU Interconnetion System

English